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## Quantum Point Contacts in Monolayer WSe<sub>2</sub>

Yuan Song<sup>1</sup>, Augusto Ghiotto<sup>1</sup>, Song Liu<sup>2</sup>, Abhay N Pasupathy<sup>1,3</sup>, Cory R Dean<sup>1</sup>, James C Hone<sup>2</sup>, Kenji Watanabe<sup>4</sup>, Takashi Taniguchi<sup>4</sup>



<sup>2</sup>Department of Mechanical Engineering, Columbia University, New York, NY 10027, USA

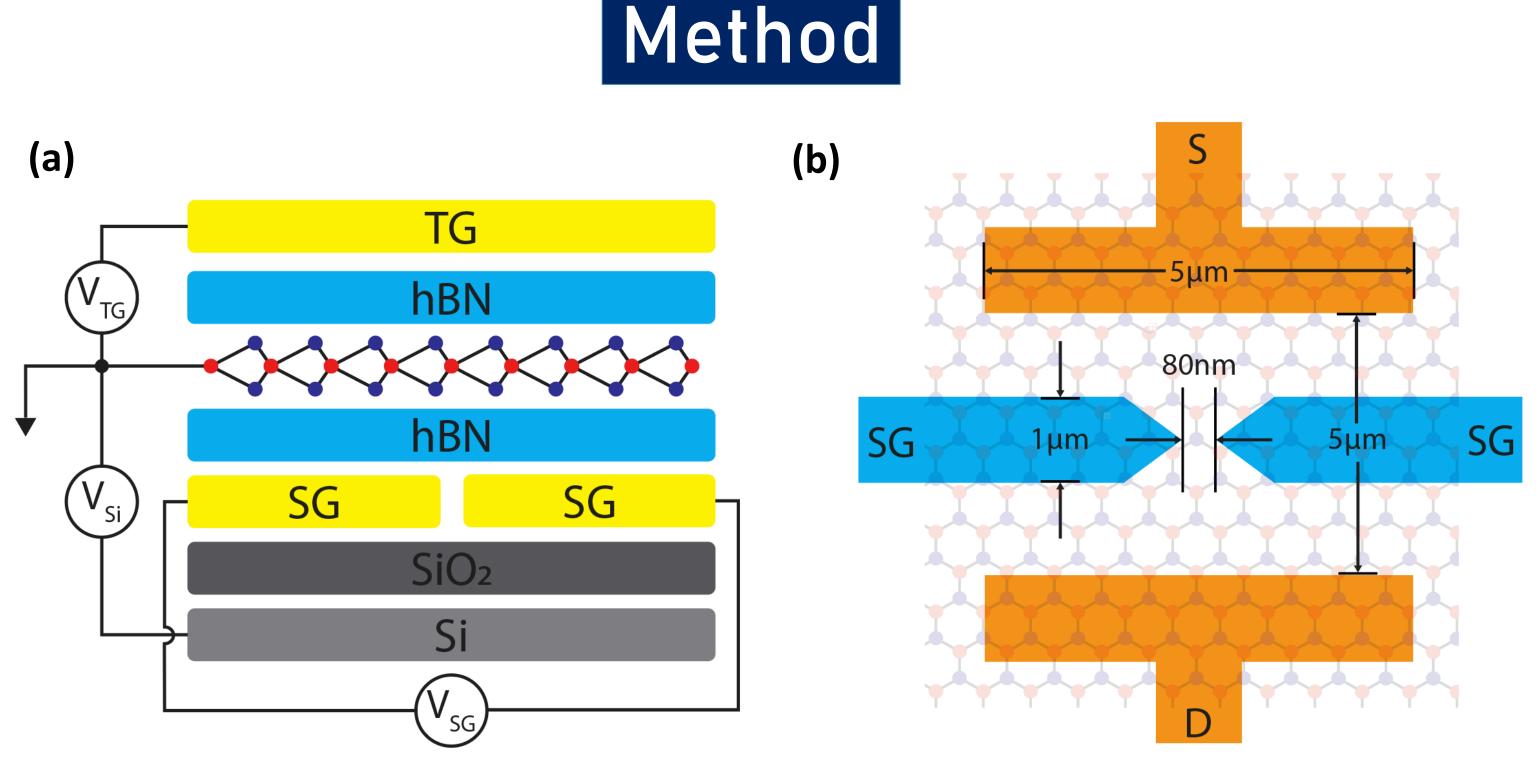
<sup>3</sup>Condensed Matter Physics and Materials Science Division, Brookhaven National Laboratory, Upton, New York 11973, USA

<sup>4</sup>National Institute for Materials Science, Namiki 1-1, Tsukuba, Ibaraki 305-0044, Japan

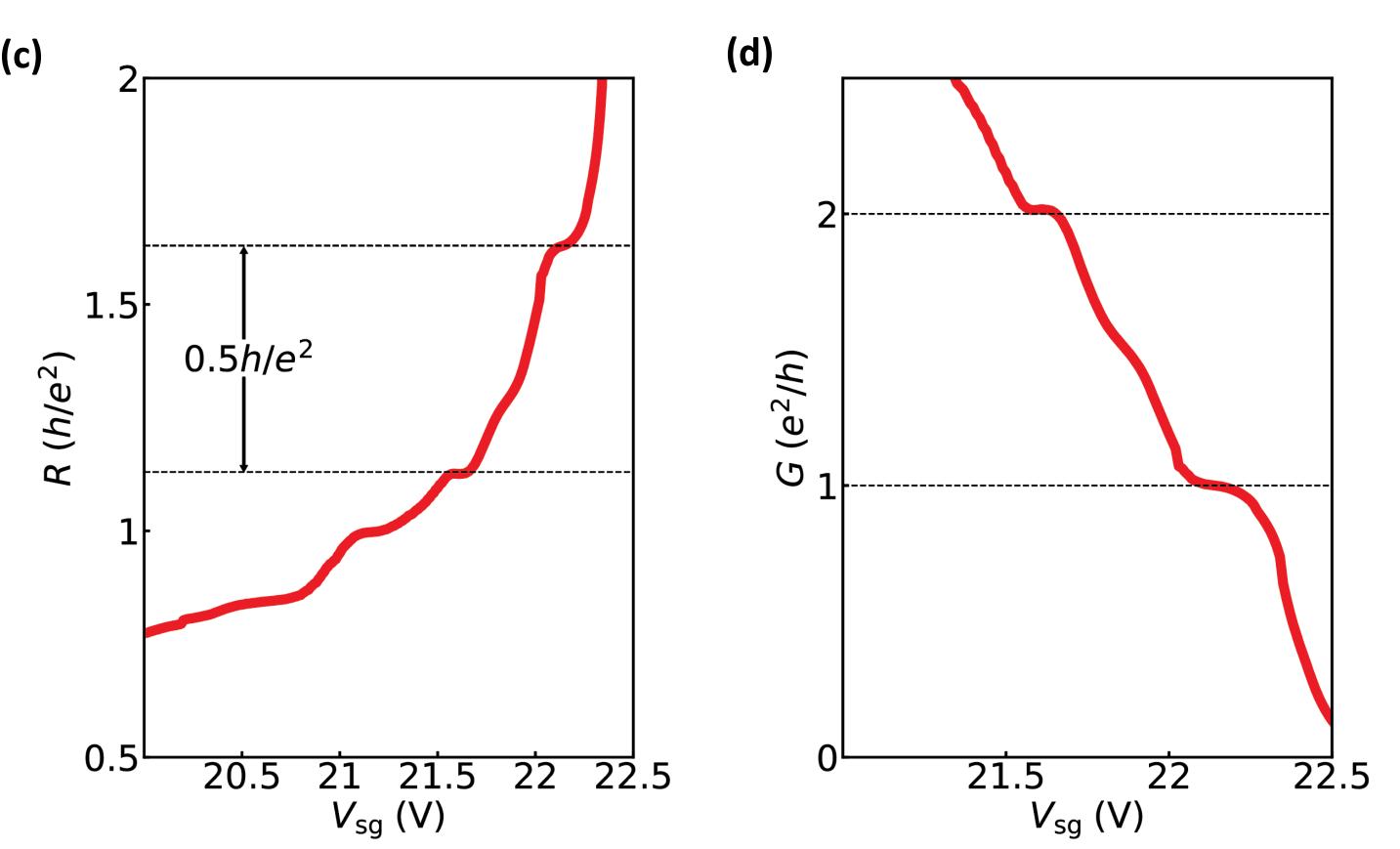


## Abstract

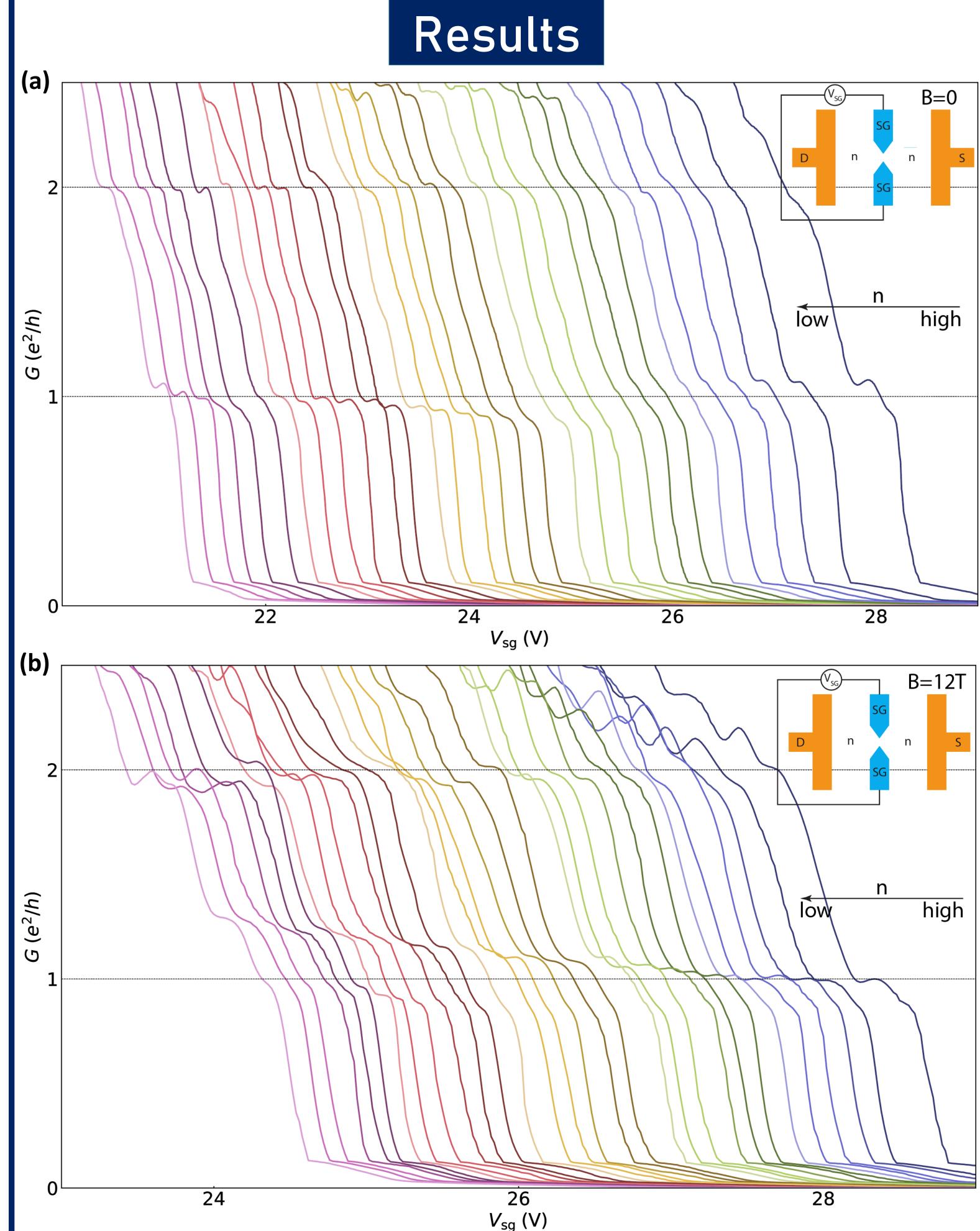
Quantum point contacts (QPCs) have been realized in III-IV semiconductor heterostructures, and more recently in bilayer graphene and trilayer  $WSe_2$  [1, 2]. These QPCs are fabricated in these two-dimensional systems using electrostatic gates, and require ballistic transport from source to drain contact to observe conductance quantization. In this work, we show that it is possible to achieve high-quality QPCs on monolayer  $WSe_2$  due to improvements in materials synthesis and contact quality. Measurements down to millikelvin temperatures show clear conductance quantization over micron-sized source-drain length scales. In  $WSe_2$ , at zero field, a two-fold degeneracy is expected at the top of the valence band due to the presence of strong spin-orbit interactions. Surprisingly, we find that the observed conductance plateaus are quantized in units of  $e^2/h$ , indicating that the spin-valley degeneracy is lifted even without the application of magnetic fields. Further, the first plateau has a systematic dependence on charge carrier density and on applied magnetic field, in a manner similar to the "0.7-anomaly" reported in previous experiments on III-V semiconductors [3].



(a-b). Schematic drawings of our device geometry. A pair of metal split-gate (SG) with an 80nm gap is first deposited on the  $SiO_2/Si$  substrate, covered by a layer of hBN (~50nm thick) with Pt/Cr prepattern contacts on top. Then the hBN/WSe<sub>2</sub> stack is dropped onto the contacts and eventually covered by a global metal top-gate (TG).



(c-d). Method for subtracting the two-probe contact resistance. A  $0.5h/e^2$  separation is found in the resistance steps (c) to locate the corresponding first two plateaus (i.e.,  $1e^2/h$  and  $2e^2/h$ ) in the conductance (d).



Conductance as a function of split-gate ( $V_{SG}$ ) at zero field (a) and B=12T (b). Curves from right to left correspond to lowering the carrier density outside the channel.

### CONTACT PERSON

Yuan (Larry) Song ys2949@columbia.edu

#### REFERENCES

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